



DC-40.0GHz Flip Chip Resistive Divider

PDR05848

DESCRIPTION

A flip chip resistive divider ideal for applications where small size and broad band performance are critical for success. This component is ideal for test measurement and optical applications. The divider is provided with all pads bumped with gold-tin solder for easy integration into hybrid assemblies.

FEATURES

- Small Size
- Frequency Stable over Temperature
- Flip Chip Solder Surface Mountable
- AuSn Bumped I/O Pads for Hybrid Assembly
- Moisture Sensitivity Level: MSL1
- Operating & Storage Temp: -55°C to +125°C
- Characteristic Impedance: 50Ω

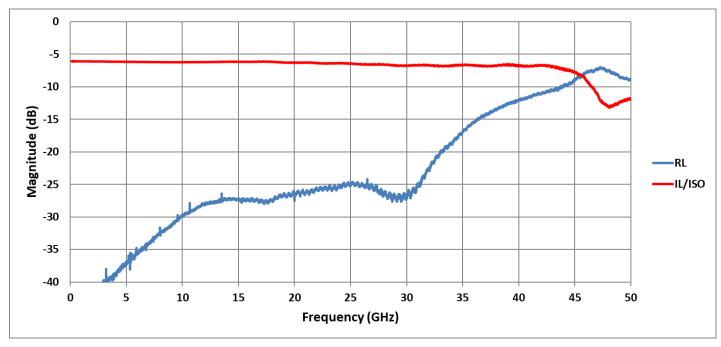


SPECIFICATIONS*

Parameter	Frequency	Min	Тур	Max
Excess Insertion Loss (dB)	DC - 40GHz		0.5dB	1dB
Return Loss (dB)	DC - 30GHz	20dB	25dB	
	30-40GHz	10dB	15dB	
Size (LxWxH)		0.075 x 0.065 x 0.010 in		
		1.905 x 1.651 x 0.254 mm		

^{*}Electrical specifications based on typical probed performance at room temperature. Insertion loss shall vary ±0.5dB over temperature.

Typical Measured Performance



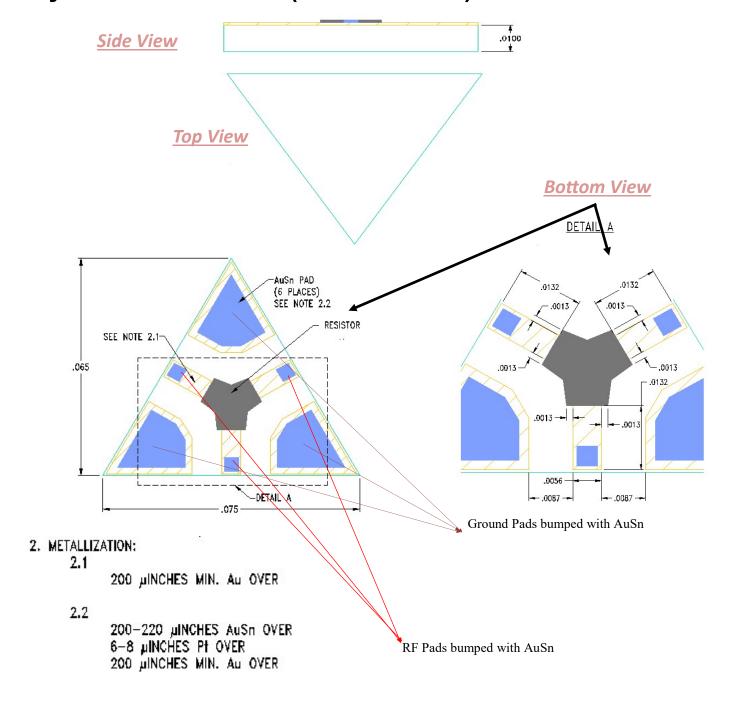


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Physical Dimensions (Unit = inches)





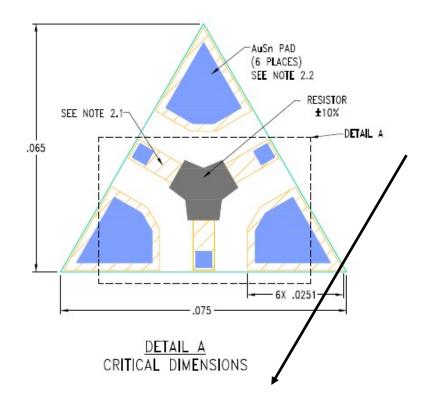
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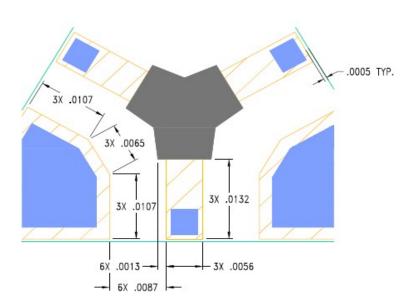
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Physical Dimensions (Unit = inches)

3X RF & 3X ground pad dimensions







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Recommended PCB Layout (Unit = inches)

